





#### 1.0A SURFACE MOUNT SUPER-FAST RECTIFIER

### **Features**

- Glass Passivated Die Construction
- Super-Fast Recovery Time For High Efficiency
- Surge Overload Rating to 40A Peak
- Ideally Suited for Automated Assembly
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

## **Mechanical Data**

- Case: SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solder Plated Terminal Solderable per MIL-STD-202, Method 208 (3)
- Lead Free Plating (Matte Tin Finish).
- Polarity: Cathode Band or Cathode Notch
- Marking Information: As Marked on Body
- Weight: 0.093 grams (Approximate)





Top Viev

Bottom View

### **Ordering Information** (Note 4)

Part Number	Compliance	Case	Packaging
MURS120 -13-F	Commercial	SMB	3000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**





# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$		
Working Peak Reverse Voltage	$V_{RWM}$	200	V
DC Blocking Voltage (Note 7)	$V_R$		
RMS Reverse Voltage	V <sub>R(RMS)</sub>	141	V
Average Rectified Output Current @ T <sub>T</sub> = +135°C	l <sub>0</sub>	1.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	40	А

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Total Capacitance (Note 6)	C <sub>T</sub>	27	pF
Typical Thermal Resistance, Junction to Terminal (Note 5)	$R_{\theta JT}$	15	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C

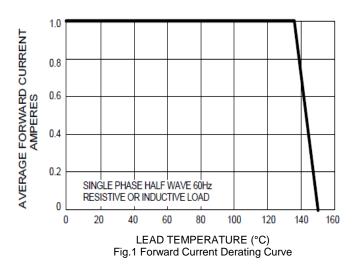
## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

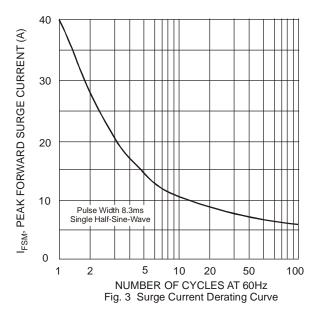
Characteristic		Symbol	Value	Unit
Forward Voltage	@ I <sub>F</sub> = 1.0A, T <sub>J</sub> = +25°C @ I <sub>F</sub> = 1.0A, T <sub>J</sub> = +150°C	$V_{FM}$	0.875 0.710	V
Peak Reverse Current at Rated DC Blocking Voltage (Note 9)	@ T <sub>A</sub> = +25°C @ T <sub>A</sub> = +150°C	I <sub>RM</sub>	2.0 50	μА
Reverse Recovery Time (Note 7)		t <sub>RR</sub>	25	ns
Forward Recovery Time (Note 8)		t <sub>RR</sub>	25	ns

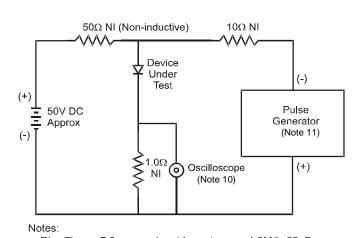
Notes:

- 5. Unit mounted on PC board with 5.0mm² (0.013mm thick) copper pads as heat sink.
- 6. Measured at 1.0MHz and applied reverse voltage of 4V DC.
- 7. Measured with  $I_F$  = 0.5A,  $I_R$  = 1.0A,  $I_{RR}$  = 0.25A. See Figure 5.
- 8. Measured with  $I_F=1.0A$ , di/dt =  $100A/\mu s$ , Duty Cycle  $\leq 2.0\%$ .
- 9. Short duration pulse test used to minimize self-heating effect.



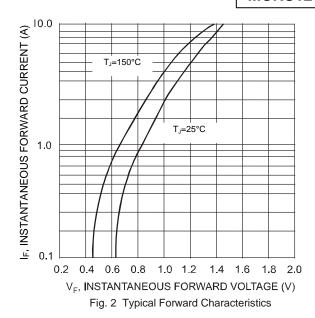


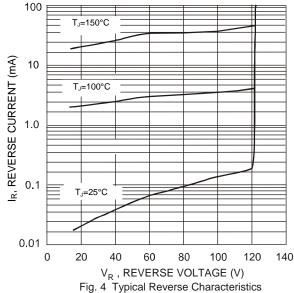


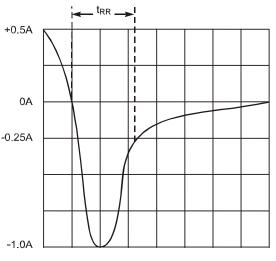


10. Rise Time = 7.0ns max. Input Impedance = 1.0MΩ, 22pF.

11. Rise Time = 10ns max. Input Impedance =  $50\Omega$ .







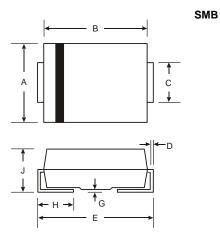
Set Time Base for 50/100 ns/cm

Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

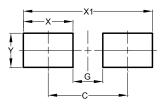


SMB			
Dim	Min	Max	
Α	3.30	3.94	
В	4.06	4.57	
С	1.96	2.21	
D	0.15	0.31	
Е	5.00	5.59	
G	0.05	0.20	
Н	0.76	1.52	
7	2.00	2.50	
All Dimensions in mm			

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### SMB



Dimensions	Value (in mm)
С	4.30
G	1.80
Х	2.50
X1	6.80
Y	2.30

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